

CMOS Digital Integrated Circuits Silicon Monolithic

TC74ACT245P,TC74ACT640P

1. Functional Description

- Octal Bus Transceiver
- TC74ACT245P:3-State, Non-Inverting
TC74ACT640P:3-State, Inverting

2. General

The TC74ACT245P, TC74ACT640P are advanced high speed CMOS OCTAL BUS TRANSCEIVERS fabricated with silicon gate and double-layer metal wiring C²MOS technology.

They achieve the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

These devices may be used as a level converter for interfacing TTL or NMOS to High Speed CMOS. The inputs are compatible with TTL, NMOS and CMOS output voltage levels.

They are intended for two-way asynchronous communication between data busses. The direction of data transmission is determined by the level of the DIR input.

The enable input (\overline{G}) can be used to disable the device so that the busses are effectively isolated.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

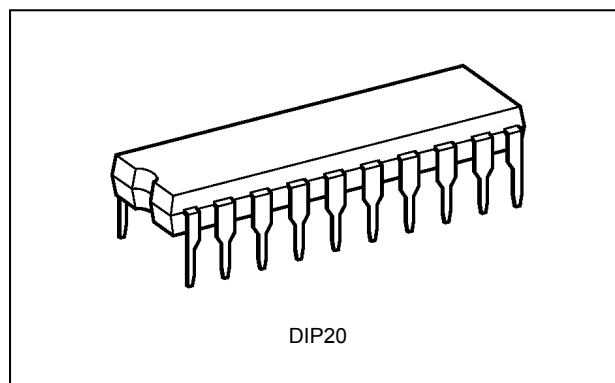
3. Features (Note)

- (1) High speed: $t_{pd} = 4.7$ ns (typ.) at $V_{CC} = 5.0$ V
- (2) Low power dissipation: $I_{CC} = 8.0$ μ A (max) at $T_a = 25$ °C
- (3) Compatible with TTL outputs: $V_{IL} = 0.8$ V (max), $V_{IH} = 2.0$ V (min)
- (4) Output current: $|I_{OH}|/I_{OL} = 24$ mA (min) ($V_{CC} = 4.5$ V)
- (5) Balanced propagation delays: $t_{PLH} \approx t_{PHL}$
- (6) Pin and function compatible with 74F245/640.

Note: Do not apply a signal to any bus pins when it is in the output mode. Damage may result.

All floating (high impedance) bus pins must have their input levels fixed by means of pull-up or pull-down resistors.

4. Packaging

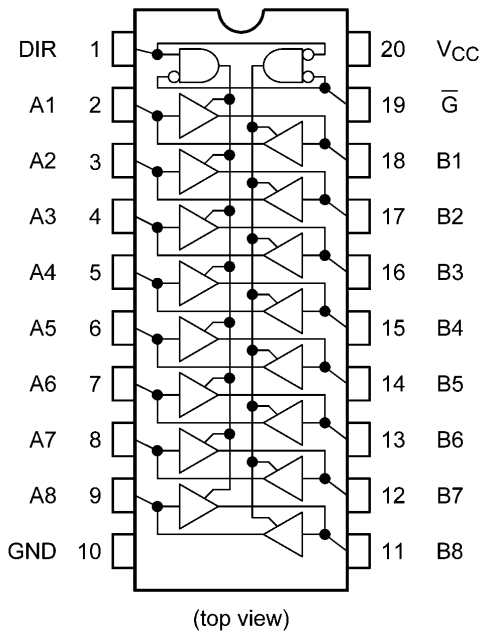


Start of commercial production

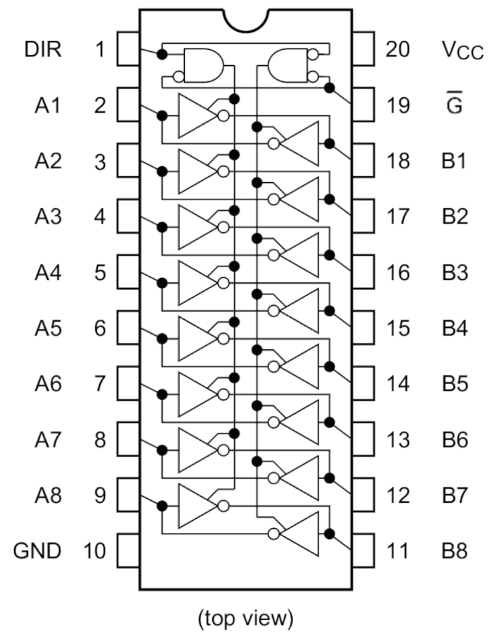
1988-10

5. Pin Assignment

TC74ACT245P

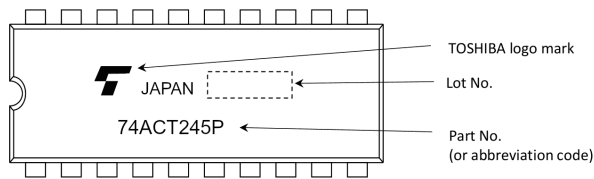


TC74ACT640P

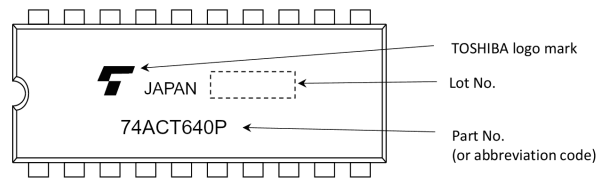


6. Marking

TC74ACT245P

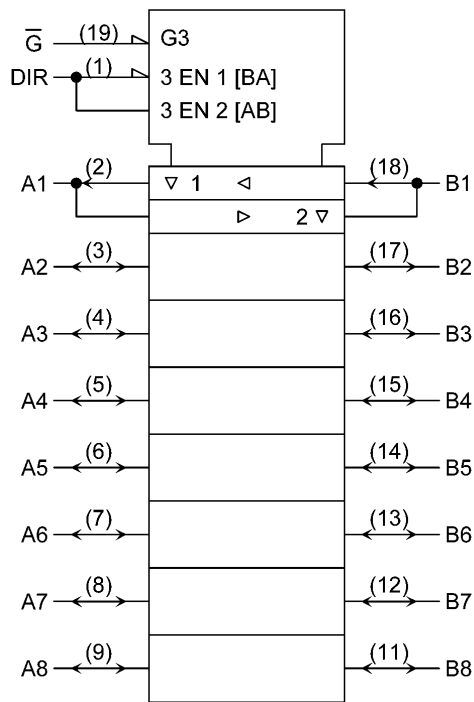


TC74ACT640P

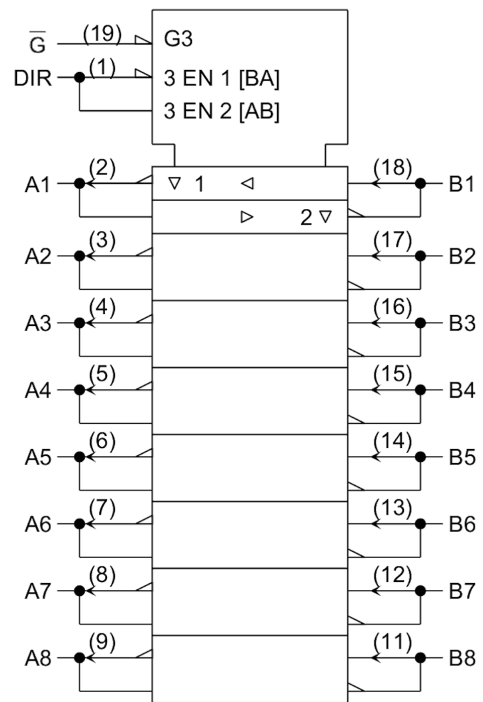


7. IEC Logic Symbol

TC74ACT245P



TC74ACT640P



8. Truth Table

| Inputs \bar{G} | Inputs DIR | Function A BUS | Function B BUS | Outputs TC74ACT245FT | Outputs TC74ACT640FT |
|---------------------|---------------|-------------------|-------------------|-------------------------|-------------------------|
| L | L | Output | Input | $A = B$ | $A = \bar{B}$ |
| L | H | Input | Output | $B = A$ | $B = \bar{A}$ |
| H | X | Z | Z | Z | Z |

X: Don't care
Z: High impedance

9. Absolute Maximum Ratings (Note)

| Characteristics | Symbol | Note | Rating | Unit |
|--------------------------|-----------|----------|------------------------|------|
| Supply voltage | V_{CC} | | -0.5 to 7.0 | V |
| Input voltage | V_{IN} | | -0.5 to $V_{CC} + 0.5$ | V |
| Output voltage | V_{OUT} | | -0.5 to $V_{CC} + 0.5$ | V |
| Input diode current | I_{IK} | | ± 20 | mA |
| Output diode current | I_{OK} | | ± 50 | mA |
| Output current | I_{OUT} | | ± 50 | mA |
| V_{CC} /ground current | I_{CC} | | ± 200 | mA |
| Power dissipation | P_D | (Note 1) | 500 | mW |
| Storage temperature | T_{stg} | | -65 to 150 | °C |

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook (“Handling Precautions”/“Derating Concept and Methods”) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: 500 mW in the range of $T_a = -40$ to 65 °C. From $T_a = 65$ to 85 °C a derating factor of -10 mW/°C shall be applied until 300 mW.

10. Operating Ranges (Note)

| Characteristics | Symbol | Rating | Unit |
|---------------------------|-----------|---------------|------|
| Supply voltage | V_{CC} | 4.5 to 5.5 | V |
| Input voltage | V_{IN} | 0 to V_{CC} | V |
| Output voltage | V_{OUT} | 0 to V_{CC} | V |
| Operating temperature | T_{opr} | -40 to 85 | °C |
| Input rise and fall times | dt/dv | 0 to 10 | ns/V |

Note: The operating ranges are required to ensure the normal operation of the device. Unused inputs and bus inputs must be tied to either V_{CC} or GND. Please connect both bus inputs and the bus outputs with V_{CC} or GND when the I/O of the bus terminal changes by the function. In this case, please note that the output is not short-circuited.

11. Electrical Characteristics

11.1. DC Characteristics (Unless otherwise specified, $T_a = 25\text{ }^\circ\text{C}$)

| Characteristics | Symbol | Test Condition | V_{CC} (V) | Min | Typ. | Max | Unit | |
|--|-----------|--|-----------------------------------|-----|------|-----------|---------------|---|
| High-level input voltage | V_{IH} | — | 4.5 to 5.5 | 2.0 | — | — | V | |
| Low-level input voltage | V_{IL} | — | 4.5 to 5.5 | — | — | 0.8 | V | |
| High-level output voltage | V_{OH} | $V_{IN} = V_{IH}$ or V_{IL} | $I_{OH} = -50\text{ }\mu\text{A}$ | 4.5 | 4.4 | 4.5 | — | V |
| | | | $I_{OH} = -24\text{ mA}$ | 4.5 | 3.94 | — | — | |
| Low-level output voltage | V_{OL} | $V_{IN} = V_{IH}$ or V_{IL} | $I_{OL} = 50\text{ }\mu\text{A}$ | 4.5 | — | 0.0 | 0.1 | V |
| | | | $I_{OL} = 24\text{ mA}$ | 4.5 | — | — | 0.36 | |
| 3-state output OFF-state leakage current | I_{OZ} | $V_{IN} = V_{IH}$ or V_{IL} $V_{OUT} = V_{CC}$ or GND | 5.5 | — | — | ± 0.5 | μA | |
| Input leakage current | I_{IN} | $V_{IN} = V_{CC}$ or GND | 5.5 | — | — | ± 0.1 | μA | |
| Quiescent supply current | I_{CC} | $V_{IN} = V_{CC}$ or GND | 5.5 | — | — | 8.0 | μA | |
| | I_{CCT} | Per input: $V_{IN} = 3.4\text{ V}$ Other input: V_{CC} or GND | 5.5 | — | — | 1.35 | mA | |

11.2. DC Characteristics (Unless otherwise specified, $T_a = -40$ to $85\text{ }^\circ\text{C}$)

| Characteristics | Symbol | Test Condition | Note | V_{CC} (V) | Min | Max | Unit | |
|--|-----------|--|-----------------------------------|--------------|-----|-----------|---------------|---|
| High-level input voltage | V_{IH} | — | | 4.5 to 5.5 | 2.0 | — | V | |
| Low-level input voltage | V_{IL} | — | | 4.5 to 5.5 | — | 0.8 | V | |
| High-level output voltage | V_{OH} | $V_{IN} = V_{IH}$ or V_{IL} | $I_{OH} = -50\text{ }\mu\text{A}$ | | 4.5 | 4.4 | — | V |
| | | | $I_{OH} = -24\text{ mA}$ | | 4.5 | 3.80 | — | |
| | | | $I_{OH} = -75\text{ mA}$ (Note 1) | | 5.5 | 3.85 | — | |
| Low-level output voltage | V_{OL} | $V_{IN} = V_{IH}$ or V_{IL} | $I_{OL} = 50\text{ }\mu\text{A}$ | | 4.5 | — | 0.1 | V |
| | | | $I_{OL} = 24\text{ mA}$ | | 4.5 | — | 0.44 | |
| | | | $I_{OL} = 75\text{ mA}$ (Note 1) | | 5.5 | — | 1.65 | |
| 3-state output OFF-state leakage current | I_{OZ} | $V_{IN} = V_{IH}$ or V_{IL} $V_{OUT} = V_{CC}$ or GND | | 5.5 | — | ± 5.0 | μA | |
| Input leakage current | I_{IN} | $V_{IN} = V_{CC}$ or GND | | 5.5 | — | ± 1.0 | μA | |
| Quiescent supply current | I_{CC} | $V_{IN} = V_{CC}$ or GND | | 5.5 | — | 80.0 | μA | |
| | I_{CCT} | Per input: $V_{IN} = 3.4\text{ V}$ Other input: V_{CC} or GND | | 5.5 | — | 1.5 | mA | |

Note 1: This spec indicates the capability of driving $50\text{ }\Omega$ transmission lines.

One output should be tested within a 10 ms maximum duration.

11.3. AC Characteristics (Unless otherwise specified, $T_a = 25\text{ °C}$, Input: $t_r = t_f = 3\text{ ns}$)

| Characteristics | Symbol | Note | Test Condition | V_{CC} (V) | Min | Typ. | Max | Unit |
|-------------------------------|--------------------|----------|---|---------------|-----|------|------|------|
| Propagation delay time | t_{PLH}, t_{PHL} | (Note 2) | $C_L = 50\text{ pF}$ $R_L = 500\text{ }\Omega$ | 5.0 ± 0.5 | — | 5.0 | 8.0 | ns |
| Propagation delay time | t_{PLH}, t_{PHL} | (Note 3) | $C_L = 50\text{ pF}$ $R_L = 500\text{ }\Omega$ | 5.0 ± 0.5 | — | 5.7 | 8.5 | ns |
| 3-state output enable time | t_{PZL}, t_{PZH} | | $C_L = 50\text{ pF}$ $R_L = 500\text{ }\Omega$ | 5.0 ± 0.5 | — | 7.3 | 12.3 | ns |
| 3-state output disable time | t_{PLZ}, t_{PHZ} | | $C_L = 50\text{ pF}$ $R_L = 500\text{ }\Omega$ | 5.0 ± 0.5 | — | 6.3 | 9.7 | ns |
| Input capacitance | C_{IN} | | DIR, \bar{G} | | — | 5 | 10 | pF |
| Bus I/O capacitance | $C_{I/O}$ | | An, Bn | | — | 13 | — | pF |
| Power dissipation capacitance | C_{PD} | (Note 1) | TC74ACT245P | | — | 38 | — | pF |
| | | | TC74ACT640P | | — | 43 | — | |

Note 1: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation.

$$I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{IN} + I_{CC}/8 \text{ (per bit)}$$

Note 2: For TC74ACT245P only

Note 3: For TC74ACT640P only

11.4. AC Characteristics (Unless otherwise specified, $T_a = -40\text{ to }85\text{ °C}$, Input: $t_r = t_f = 3\text{ ns}$)

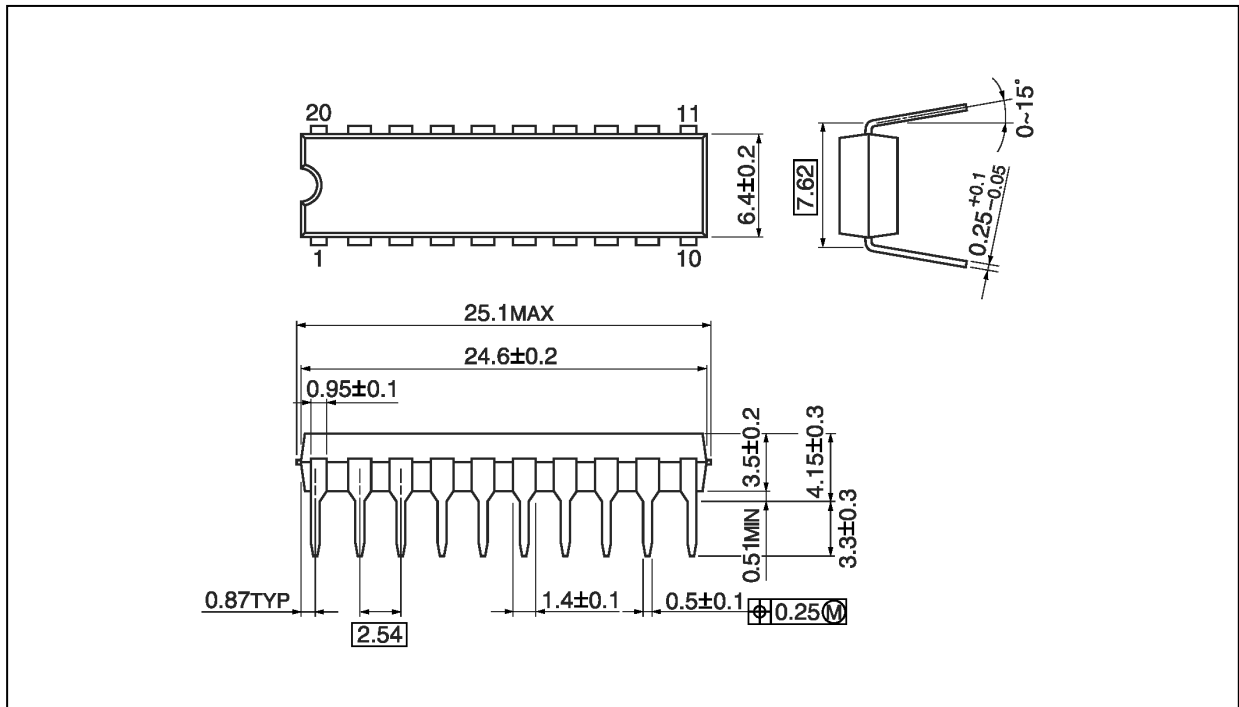
| Characteristics | Symbol | Note | Test Condition | V_{CC} (V) | Min | Max | Unit |
|-----------------------------|--------------------|----------|---|---------------|-----|------|------|
| Propagation delay time | t_{PLH}, t_{PHL} | (Note 1) | $C_L = 50\text{ pF}$ $R_L = 500\text{ }\Omega$ | 5.0 ± 0.5 | 1.0 | 9.0 | ns |
| Propagation delay time | t_{PLH}, t_{PHL} | (Note 2) | $C_L = 50\text{ pF}$ $R_L = 500\text{ }\Omega$ | 5.0 ± 0.5 | 1.0 | 9.5 | ns |
| 3-state output enable time | t_{PZL}, t_{PZH} | | $C_L = 50\text{ pF}$ $R_L = 500\text{ }\Omega$ | 5.0 ± 0.5 | 1.0 | 14.0 | ns |
| 3-state output disable time | t_{PLZ}, t_{PHZ} | | $C_L = 50\text{ pF}$ $R_L = 500\text{ }\Omega$ | 5.0 ± 0.5 | 1.0 | 11.0 | ns |
| Input capacitance | C_{IN} | | DIR, \bar{G} | | — | 10 | pF |

Note 1: For TC74ACT245P only

Note 2: For TC74ACT640P only

Package Dimensions

Unit: mm



Weight: 1.30 g (typ.)

| |
|-----------------|
| Package Name(s) |
| Nickname: DIP20 |

RESTRICTIONS ON PRODUCT USE

Toshiba Corporation and its subsidiaries and affiliates are collectively referred to as "TOSHIBA".

Hardware, software and systems described in this document are collectively referred to as "Product".

- TOSHIBA reserves the right to make changes to the information in this document and related Product without notice.
- This document and any information herein may not be reproduced without prior written permission from TOSHIBA. Even with TOSHIBA's written permission, reproduction is permissible only if reproduction is without alteration/omission.
- Though TOSHIBA works continually to improve Product's quality and reliability, Product can malfunction or fail. Customers are responsible for complying with safety standards and for providing adequate designs and safeguards for their hardware, software and systems which minimize risk and avoid situations in which a malfunction or failure of Product could cause loss of human life, bodily injury or damage to property, including data loss or corruption. Before customers use the Product, create designs including the Product, or incorporate the Product into their own applications, customers must also refer to and comply with (a) the latest versions of all relevant TOSHIBA information, including without limitation, this document, the specifications, the data sheets and application notes for Product and the precautions and conditions set forth in the "TOSHIBA Semiconductor Reliability Handbook" and (b) the instructions for the application with which the Product will be used with or for. Customers are solely responsible for all aspects of their own product design or applications, including but not limited to (a) determining the appropriateness of the use of this Product in such design or applications; (b) evaluating and determining the applicability of any information contained in this document, or in charts, diagrams, programs, algorithms, sample application circuits, or any other referenced documents; and (c) validating all operating parameters for such designs and applications. **TOSHIBA ASSUMES NO LIABILITY FOR CUSTOMERS' PRODUCT DESIGN OR APPLICATIONS.**
- **PRODUCT IS NEITHER INTENDED NOR WARRANTED FOR USE IN EQUIPMENTS OR SYSTEMS THAT REQUIRE EXTRAORDINARILY HIGH LEVELS OF QUALITY AND/OR RELIABILITY, AND/OR A MALFUNCTION OR FAILURE OF WHICH MAY CAUSE LOSS OF HUMAN LIFE, BODILY INJURY, SERIOUS PROPERTY DAMAGE AND/OR SERIOUS PUBLIC IMPACT ("UNINTENDED USE").** Except for specific applications as expressly stated in this document, Unintended Use includes, without limitation, equipment used in nuclear facilities, equipment used in the aerospace industry, Class 3 medical devices, equipment used for automobiles, and military vehicles and munitions. **IF YOU USE PRODUCT FOR UNINTENDED USE, TOSHIBA ASSUMES NO LIABILITY FOR PRODUCT.** For details, please contact your TOSHIBA sales representative or contact us via our website.
- Do not disassemble, analyze, reverse-engineer, alter, modify, translate or copy Product, whether in whole or in part.
- Product shall not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable laws or regulations.
- The information contained herein is presented only as guidance for Product use. No responsibility is assumed by TOSHIBA for any infringement of patents or any other intellectual property rights of third parties that may result from the use of Product. No license to any intellectual property right is granted by this document, whether express or implied, by estoppel or otherwise.
- **ABSENT A WRITTEN SIGNED AGREEMENT, EXCEPT AS PROVIDED IN THE RELEVANT TERMS AND CONDITIONS OF SALE FOR PRODUCT, AND TO THE MAXIMUM EXTENT ALLOWABLE BY LAW, TOSHIBA (1) ASSUMES NO LIABILITY WHATSOEVER, INCLUDING WITHOUT LIMITATION, INDIRECT, CONSEQUENTIAL, SPECIAL, OR INCIDENTAL DAMAGES OR LOSS, INCLUDING WITHOUT LIMITATION, LOSS OF PROFITS, LOSS OF OPPORTUNITIES, BUSINESS INTERRUPTION AND LOSS OF DATA, AND (2) DISCLAIMS ANY AND ALL EXPRESS OR IMPLIED WARRANTIES AND CONDITIONS RELATED TO SALE, USE OF PRODUCT, OR INFORMATION, INCLUDING WARRANTIES OR CONDITIONS OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, ACCURACY OF INFORMATION, OR NONINFRINGEMENT.**
- Do not use or otherwise make available Product or related software or technology for any military purposes, including without limitation, for the design, development, use, stockpiling or manufacturing of nuclear, chemical, or biological weapons or missile technology products (mass destruction weapons). Product and related software and technology may be controlled under the applicable export laws and regulations including, without limitation, the Japanese Foreign Exchange and Foreign Trade Law and the U.S. Export Administration Regulations. Export and re-export of Product or related software or technology are strictly prohibited except in compliance with all applicable export laws and regulations.
- Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. Please use Product in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive. **TOSHIBA ASSUMES NO LIABILITY FOR DAMAGES OR LOSSES OCCURRING AS A RESULT OF NONCOMPLIANCE WITH APPLICABLE LAWS AND REGULATIONS.**